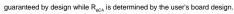
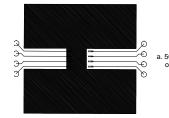


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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		30			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_D = 250 \ \mu$ A, Referenced to $25 \ ^{\circ}C$			33		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$				1	μA
			T _J = 55°C			10	μA
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
	CTERISTICS (Note 2)						
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	I_{D} = 250 µA, Referenced t	o 25 °C		-4.5		mV /⁰C
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.6	3	V
			T_ =125°C	0.8	1.3	2.4	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}$			0.008	0.0095	Ω
			T_ =125°C		0.012	0.016	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10.5 \text{ A}$			0.0105	0.013	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$		25			Α
9 _{FS}	Forward Transconductance	V _{DS} = 15 V, I _D = 12.5 A			35		S
DYNAMIC (CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1.0 MHz			2180		pF
C _{oss}	Output Capacitance	f = 1.0 MHz	f = 1.0 MHz		500		pF
C _{rss}	Reverse Transfer Capacitance				255		pF
SWITCHING	CHARACTERISTICS (Note 2)				_		
t _{D(on)}	Turn - On Delay Time	V _{DS} = 10 V, I _D = 1 A	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}$		13	24	ns
ţ,	Turn - On Rise Time	$V_{GS} = 10 \text{ V}$, $R_{GEN} = 6 \Omega$			14	26	ns
t _{D(off)}	Turn - Off Delay Time				43	70	ns
t _r	Turn - Off Fall Time				15	27	ns
Q _g	Total Gate Charge	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 12.5 \text{ A},$ $V_{GS} = 5 \text{ V}$			23	33	nC
Q _{gs}	Gate-Source Charge				7		nC
Q _{gd}	Gate-Drain Charge				11		nC
DRAIN-SOL	RCE DIODE CHARACTERISTICS AND MAXIN	IUM RATINGS					
l _s	Maximum Continuous Drain-Source Diode F	prward Current				2.1	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.1 A$ (Note 2)			0.72	1.2	V



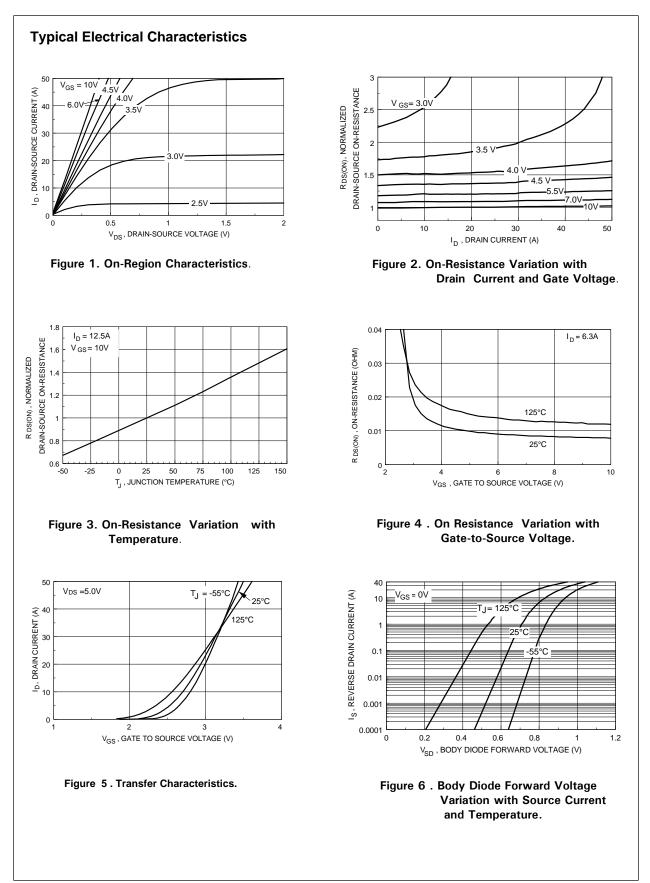




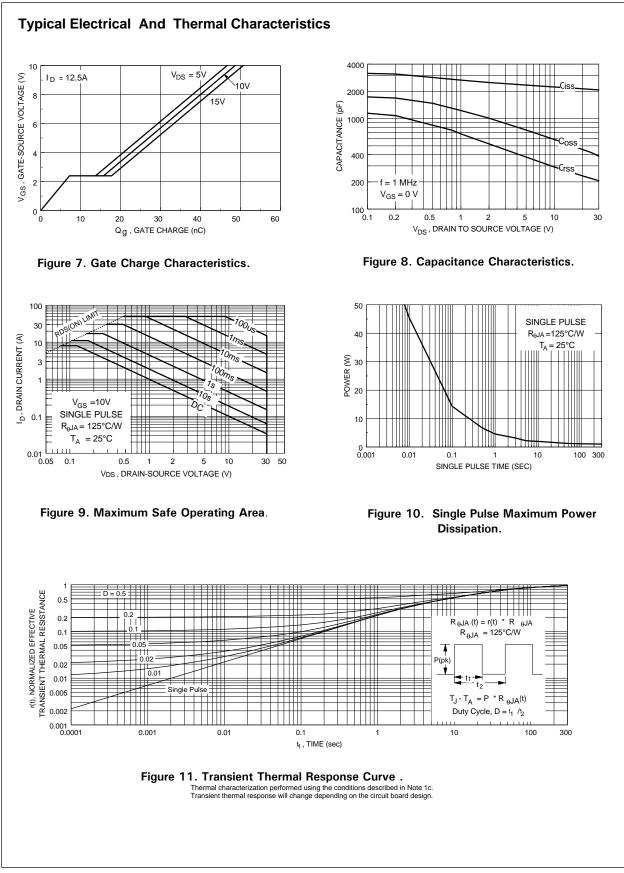




Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.



Si4822DY Rev.A



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